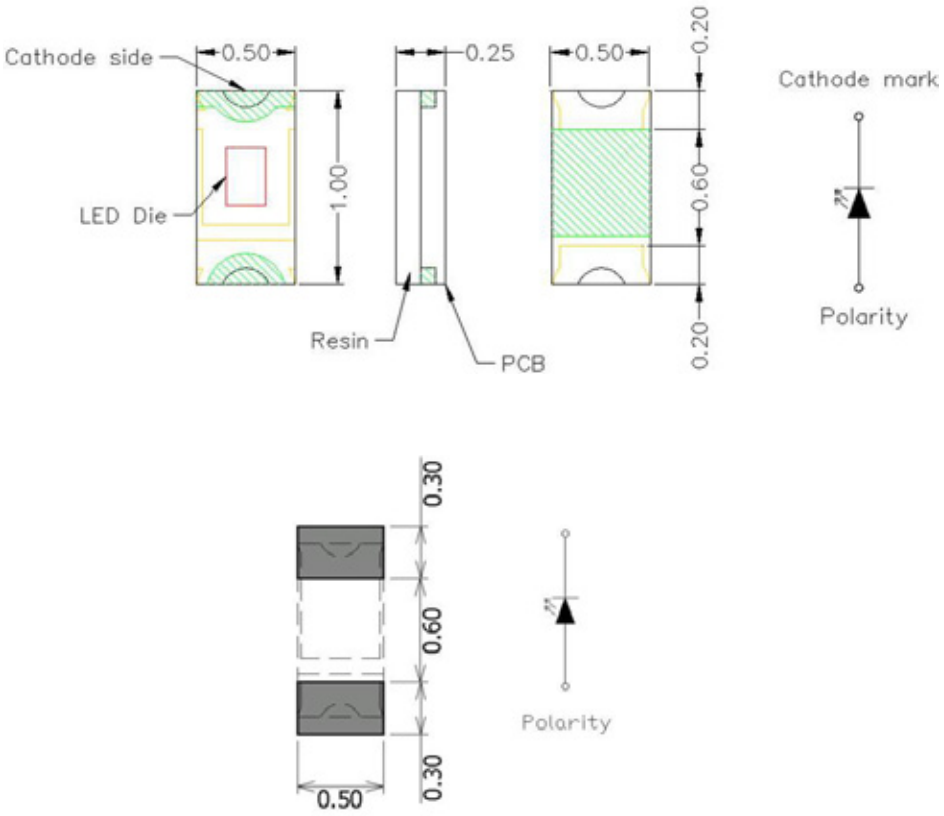
SPECIFICATION CS42EW2C

PACKAGE OUTLINES



Notes:
1. All dimensions are in millimeters (inches).
2. Tolerance is ± 0.25mm (0.01”) unless otherwised noted.
3. Specifications are subject to change without notice.

Part Number	Chip Material	Color of Emission	Lens Type	Viewing Angle
CS42EW2C	InGaN	White	Yellow Diffused	130°

ABSOLUTE MAXIMUM RATINGS (TA=25°C)

Parameter	Symbol	Max Rating	Unit
Forward Current	I_F	5	mA
Reverse Current @ 5V	I_R	10	μA
Power Dissipation	Pd	16.25	mW
Operating Temperature Range	T_{OP}	-40~+85	°C
Storage Temperature Range	T_{STG}	-40~+100	°C
Peak Pulsing Current (1/10 duty f = 10KHz)	I_{FP}	20	mA
Soldering Temperature	T_{SOL}	Max 260°C for 10 sec Max	

OPTICAL-ELECTRICAL CHARACTERISTICS (TA=25°C)

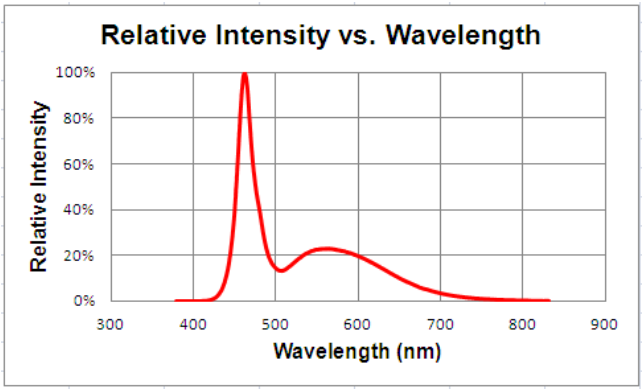
Parameter	Symbol	Test Condition	Value			Unit
			Min	Typ	Max	
Luminous Intensity	Iv	I_F = 5mA	-	140	-	mcd
Forward Voltage	V_F	I_F = 5mA	-	2.8	3.2	V
Reverse Leakage Current	I_R	V_R = 5V	-	10	-	μA
Viewing Angle at 50% Iv	2θ1/2	I_F = 5mA	-	130	-	Deg
Chromaticity Coordinates	X	I_F = 5mA	-	0.29	-	-
	Y	I_F = 5mA	-	0.29	-	-

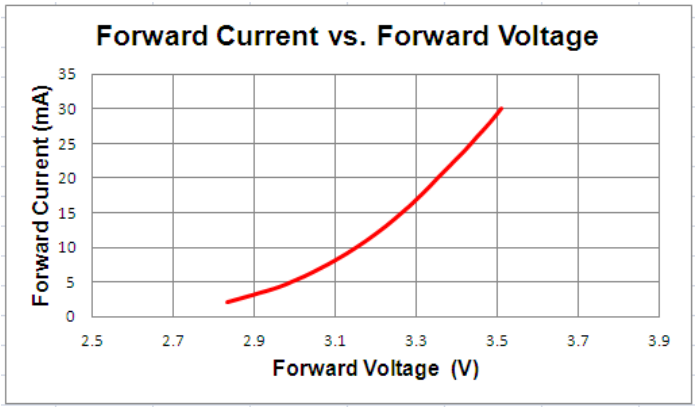
*Tolerance of viewing angle: -10 / +5 deg.

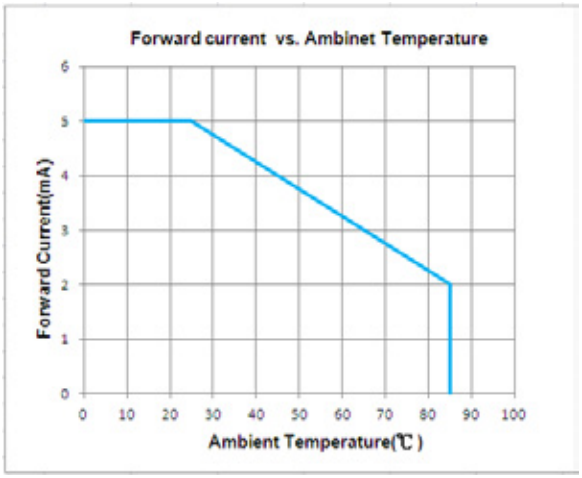
RoHS Compliant Lead Free

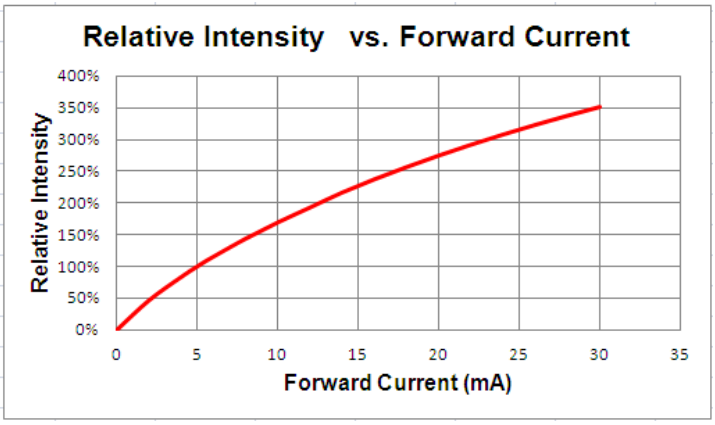
ChromeLED Corp. reserves the right to make changes at any time in order to supply the best product possible. The most current version of this document will always be available at: www.chromeled.com

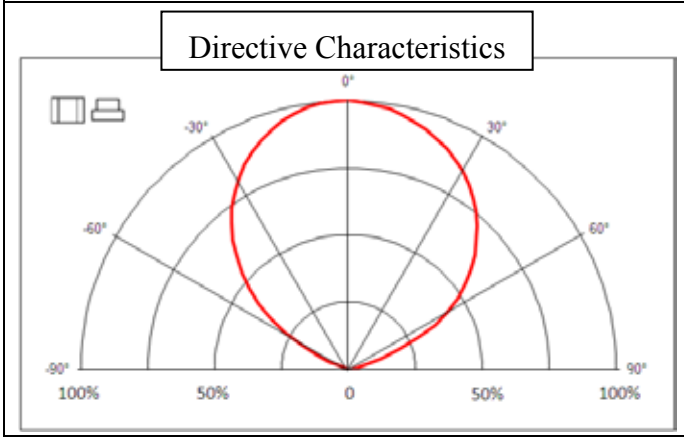
OPTICAL CHARACTERISTIC CURVES

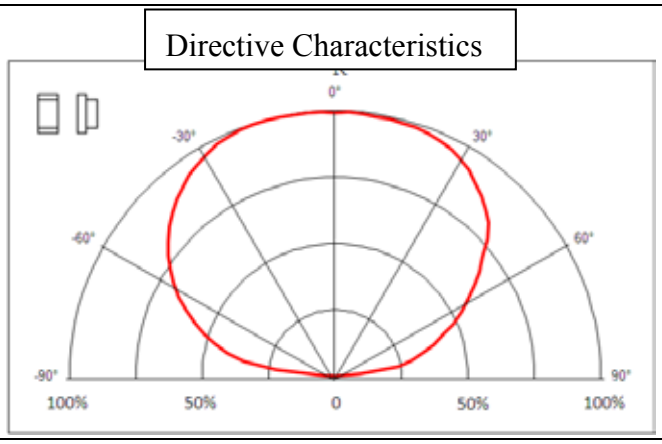






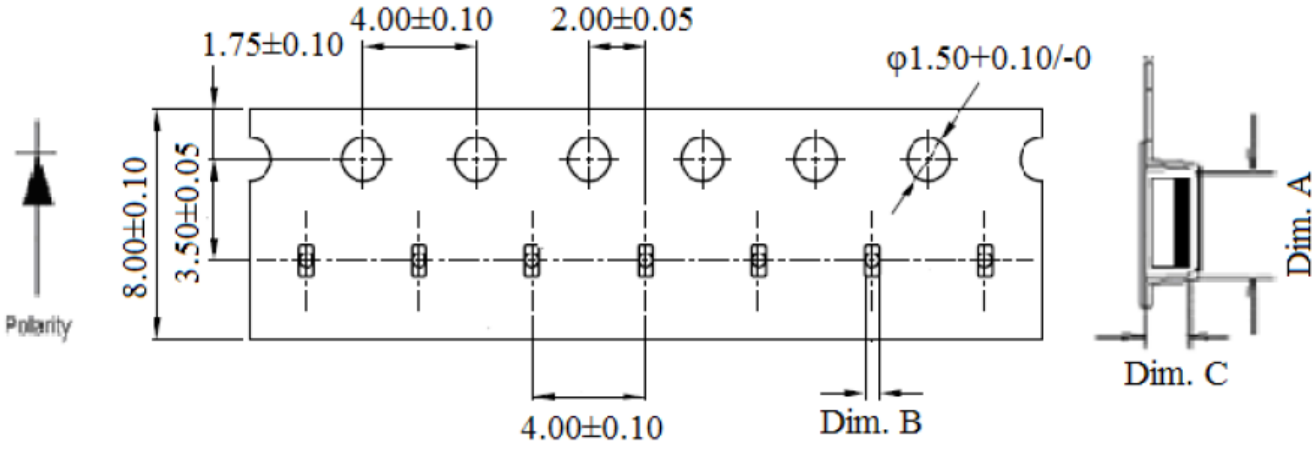






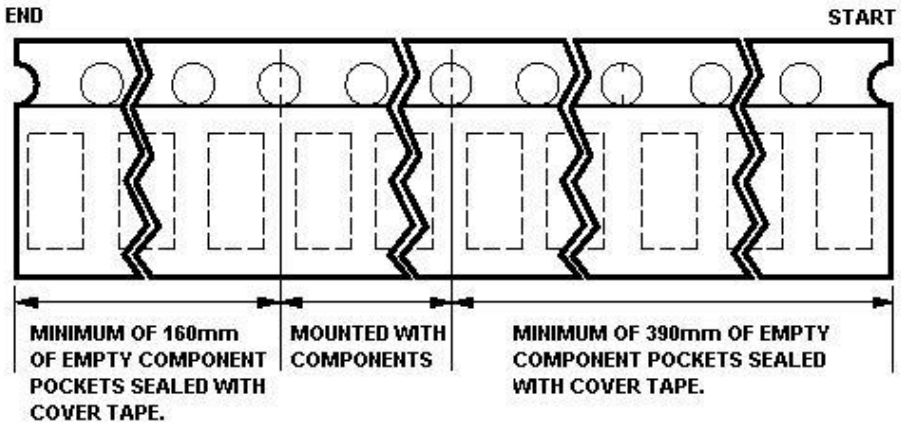
PACKAGING SPECIFICATION

Tape Dimension



Dim. A	Dim. B	Dim. C	Q'ty/Reel
1.11±0.03	0.60±0.03	0.38±0.03	3K

Unit: mm



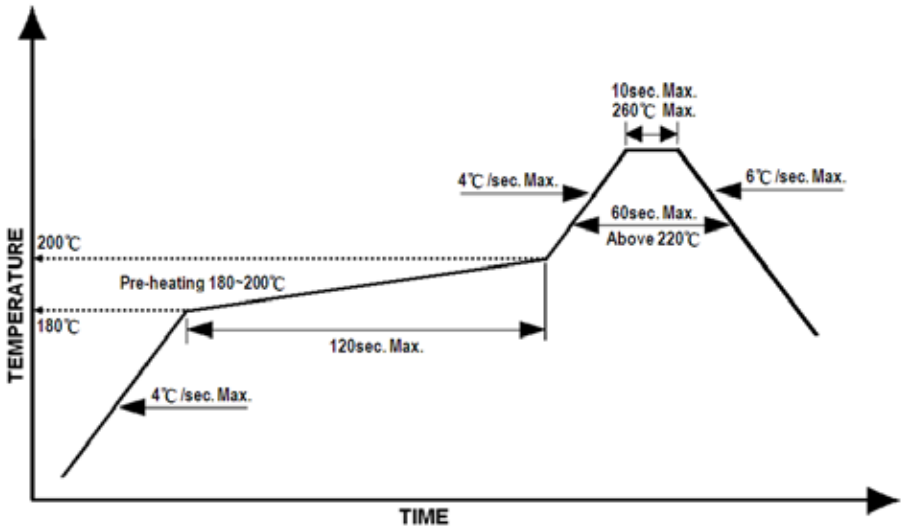
SOLDERING CONDITIONS

Reflow Soldering

Recommend soldering paste specifications:

1. Operating temp.: Above 220℃ ,60 sec.
2. Peak temp.:260℃ Max.,10sec Max.
3. Reflow soldering should not be done more than two times.
4. Never attempt next process until the component is cooled down to room temperature after reflow.
5. The recommended reflow soldering profile (measured on the surface of the LED terminal) is as following:

Lead-free Solder Profile



Reworking

- Rework should be completed within 5 seconds under 260℃.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50℃ x 30sec. or <30℃ x 3min
- Ultrasonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 ℃ max, <3min